I²S Input, High Efficiency, 6V Charge Pump, Digital Smart K Audio Amplifier

FEATURES

- Adaptive Charge Pump with total efficiency up to 86%
- Supports Speaker, Receiver 2-in-1 application
- High RF noise suppression, eliminate the TDD noise completely
- Low noise: 15μV
- THD+N: 0.02%
- Extensive Pop-Click Suppression
- Volume control(from -96dB to 0dB)
- I²S interface:
 - I²S, Left-Justified and Right-Justified
 - Input Sample Rates from 8kHz to 96kHz
 - Data Width: 16, 20, 24, 32 Bits
- I²C-bus control interface(400kHz)
- Power Supplies:
 - VDD: 3.0V~5.5V
 - DVDD: 1.65V~1.95V
- Short-Circuit Protection, Over-Temperature Protection, Under-Voltage Protection and Over-Voltage Protection
- FCQFN 2X3-20L Package

APPLICATIONS

- Mobile phones
- Tablets
- Portable Audio Devices

DESCRIPTION

The AW8838 is an I²S input, high efficiency digital Smart K audio amplifier with an integrated 6V adaptive charge pump, sound quality enhancement algorithms and speaker protection. Due to its 15μ V noise floor and ultra-low distortion, clean listening is guaranteed. It can delivers 1.8W (RMS, THD+N = 1%) output power into an 8 Ω speaker at a battery voltage of 4.2V.

The AW8838 integrates a high-efficiency adaptive charge pump as the Class-D amplifier supply rail. The output voltage of charge pump is only raised when necessary. This improves the output dynamic range of audio signal while limiting quiescent power consumption.

The AW8838 features AWINIC proprietary AGC algorithm that prevents clipping noise and improves sound quality.

The AW8838 supports speaker and receiver 2-in-1 applications. In the receiver application, it connects VDD directly to the Class-D amplifier power supply.

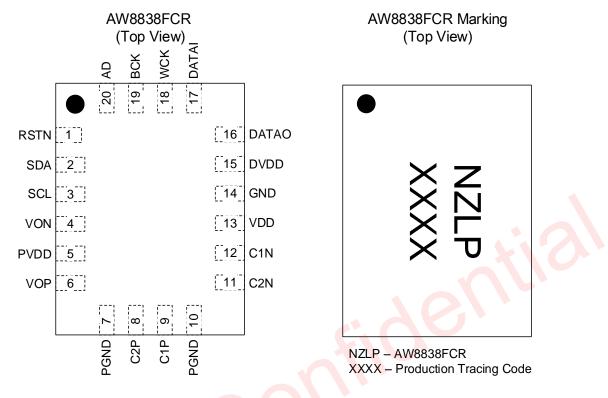
The AW8838 features high RF suppression and eliminates TDD noise completely benefited from the digital audio input interface. General settings are communicated via an I²C-bus interface, and the device address is configurable.

The AW8838 offers Short Circuit Protection, Over-Temperature Protection, Under-Voltage Protection and Over-Voltage Protection to protect the device.

AW8838 is available in FCQFN 2X3-20L package.

PIN CONFIGURATION AND TOP MARK

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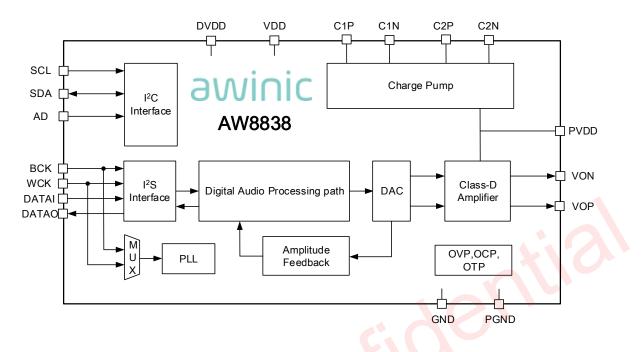


PIN DEFINITION

No.	NAME	DESCRIPTION	
1	RSTN	Active low hardware reset	
2	SDA	I ² C data I/O	
3	SCL	I ² C clock input	
4	VON	Inverting Class-D output	
5	PVDD	Charge Pump output	
6	VOP	Non-inverting Class-D output	
7	PGND	Power GND	
8	C2P	Non-Inverting terminal of flying capacitance C2	
9	C1P	Non-Inverting terminal of flying capacitance C1	
10	PGND	Power GND	
11	C2N	Inverting terminal of flying capacitance C2	
12	C1N	Inverting terminal of flying capacitance C1	
13	VDD	Battery power supply	
14	GND	GND	
15	DVDD	Digital power supply	
16	DATAO	I ² S data out	
17	DATAI	I ² S data input	
18	WCK	I ² S word select input	
19	BCK	I ² S bit clock input	
20	AD	I ² C address select input	

FUNCTIONAL BLOCK DIAGRAM

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TYPICAL APPLICATION CIRCUITS

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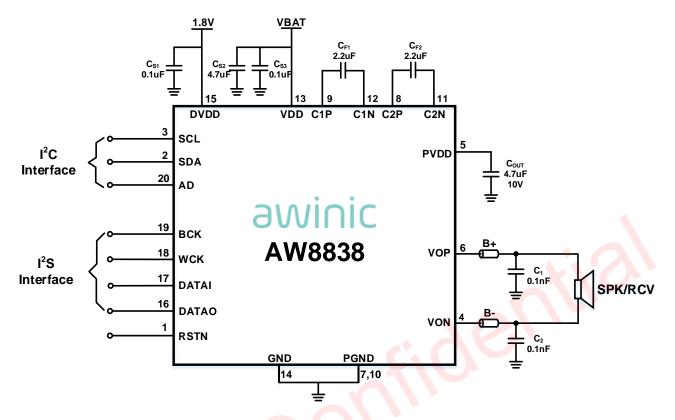


Figure 3 AW8838 Application Circuit

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ORDERING INFORMATION

Part Number	Temperature	Package	Marking	Moisture Sensitivity Level	Environmental Information	Delivery Form
AW8838FCR	-40°C ~ 85°C	FCQFN 2X3-20L	NZLP	MSL1	RoHS+HF	6000 units/ Tape and Reel

ABSOLUTE MAXIMUM RATINGS(NOTE1)

PARA	METERS	RANGE
Battery Sup	ply Voltage VDD	-0.3V to 6V
Digital Supp	y Voltage DVDD	-0.3V to 2V
Charge Pump C	utput Voltage PVDD	-0.3V to 7V
Output Valtage Denge	VOP, VON, C1P, C2P	-0.3V to PVDD + 0.3V
Output Voltage Range	C1N, C2N	-0.3V to VDD + 0.3V
Digital Input Valtage	RSTN, AD, SCL, SDA	-0.3V to VDD + 0.3V
Digital Input Voltage	BCK, WCK, DATAI	-0.3V to DVDD + 0.3V
Minimum lo	ad resistance R∟	5Ω
Package Ther	mal Resistance θ _{JA}	60°C/W
Ambient Ter	nperature Range	-40°C to 85°C
Maximum Junction	on Temperature T _{JMAX}	165°C
Storage Temp	erature Range Tstg	-65°C to 150°C
Lead Temperature	(Soldering 10 Seconds)	260°C
	ESD Rating	
HBM(Human	Body Model) ^(Note 2)	+4000V
CDM(Charge Device Model) (Note 3)		±2000V
	Latch-up	
Toot Condi	tion: JESD78E	+IT: 450mA
rest Condi	IUII: JESDIOE	-IT: -450mA

NOTE1: Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE2: The human body model is a 100pF capacitor discharged through a $1.5k\Omega$ resistor into each pin. Test method: MIL-STD-883J Method 3015.9

NOTE3: Test method: ESDA/JEDEC JS-002-2014

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS

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Test condition :T_A=25°C ,VDD=3.6V ,DVDD=1.8V , R_L=8 Ω +33 μ H ,f_{in}=1kHz ,f_S=48kHz for typical values (unless otherwise noted)

Symbol	Description	Test Conditions	Min	Тур.	Max	Units
V_{DD}	Battery supply voltage	On pin VDD	3		5.5	V
Vdvdd	Digital supply voltage	On pin DVDD	1.65	1.8	1.95	V
		Operating mode, Charge Pump off		3		mA
IVDD	Battery supply current	Operating mode, Charge Pump on		8		mA
		Power down mode		0.3	2	μA
I	Digital augusty aurrent	Operating mode		1.2		mA
DVDD	Digital supply current	Power down mode		3		μA
Ton	Startup time		XX	2.5		ms
Charge P	Pump					
PVDD	Charge Pump output voltage	V _{DD} =3V to 4.0V		1.5 x V _{DD}		V
		V _{DD} > 4.0V		6		V
V _{HYS}	OVP hysteresis voltage	V _{DD} > 4.0V		50		mV
FCP	Operating Frequency	fs=48kHz		1.06		MHz
T _{ST}	Soft-start time	С _{оυт} =4.7µF		1		ms
ηср	Charge Pump efficiency	V _{DD} =3.6V, I _{LOAD} =200mA		94		%
LIMIT	PVDD short limit current			250		mA
Class-D						
0		THD+N=1%, RL= 6Ω +33µH, V _{DD} =4.2V		2.15		W
Do		THD+N=10%, $R_L=6\Omega+33\mu H$, $V_{DD}=4.2V$		2.75		W
Po	Speaker output power	THD+N=1%, R _L = 8Ω +33µH, V _{DD} =4.2V		1.8		W
		THD+N=10%, R _L =8Ω+33µH, V _{DD} =4.2V		2.2		W
-	Total efficiency (Charge	V _{DD} =4.2V, Po=1.0W, R _L =8Ω+33μH		86		%
η	Pump + Class-D)	V_{DD} =4.2V, Po=1.0W, R_L =6 Ω +33 μ H		85		%
Vos	Output offset voltage		-30	0	30	mV

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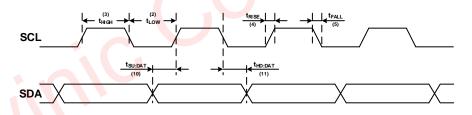
AW8838

Jul. 2020 V1.5

Symbol	Description	Test Conditio	ons	Min	Тур.	Max	Units
R_{dson}	Total drain-source on-state resistance	High side MOS + Lo MOS	ow side		350		mΩ
THD+N	Total harmonic distortion plus noise	V _{DD} =4.2V, Po=0.5W R⊾=8Ω+33µH	I,		0.02		%
E _N	Receiver mode output noise	A-weighting			15		μV
	Speaker mode output noise	A-weighting			22		μV
SNR	Signal-to-noise ratio	V _{DD} =4.2V, Po=1.8W R∟=8Ω+33µH, A-weighting	Ι,		105		dB
PSRR	Power supply rejection ratio	V _{DD} =4.2V,	217Hz		-85		dB
FORK		$V_{p-p_sin}=200mV$	1kHz		-80		dB
Digital Lo	ogical Interface						
VIH	High-level digital input voltage	BCK, WCK, DATAI Pin		0.7 x V _{DVDD}	5	VDVDD	V
VIL	Low-level digital input voltage			AP		0.3 x V _{DVDD}	V
Vін	High-level digital input voltage			0.7 x Vdvdd		3.6	V
VIL	Low-level digital input voltage	RSTN, SCL, SDA, 7	AD PIN			0.3 x V _{DVDD}	V
V _{он}	High-level digital input voltage	Iout=-2mA		V _{DVDD} - 0.45			V
Vol	Low-level digital input voltage	lout=2mA				0.45	V
Protectio	n						
Tsd	Over temperature protection threshold				160		°C
Tsdr	Over temperature protection recovery threshold				130		°C
	Under-voltage protection voltage				2.5		V
UVP	Under-voltage protection hysteresis voltage				100		mV

I²C INTERFACE TIMING

	Parameter		BA :	Terre	Maria	Lin:to
No.	Sym	Name	Min	Тур.	Мах	Units
1	fscl	SCL Clock frequency			400	kHz
2	t _{LOW}	SCL Low level Duration	1.3			μs
3	t _{ніGH}	SCL High level Duration	0.6			μs
4	trise	SCL, SDA rise time			0.3	μs
5	tFALL	SCL, SDA fall time			0.3	μs
6	tsu:sta	Setup time SCL to START state	0.6			μs
7	t _{HD:STA}	(Repeat-start) Start condition hold time	0.6			μs
8	tsu:sto	Stop condition setup time	0.6			μs
9	t BUF	the Bus idle time START state to STOP state	1.3			μs
10	tsu:dat	SDA setup time	0.1			μs
11	thd:dat	SDA hold time	10			ns





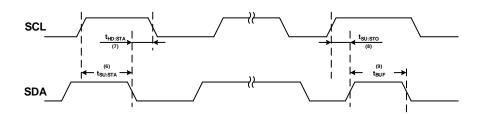
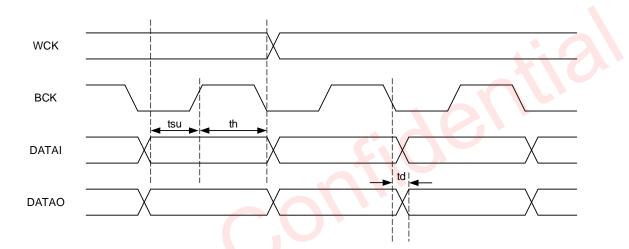


Figure 5 The timing relationship between START and STOP state

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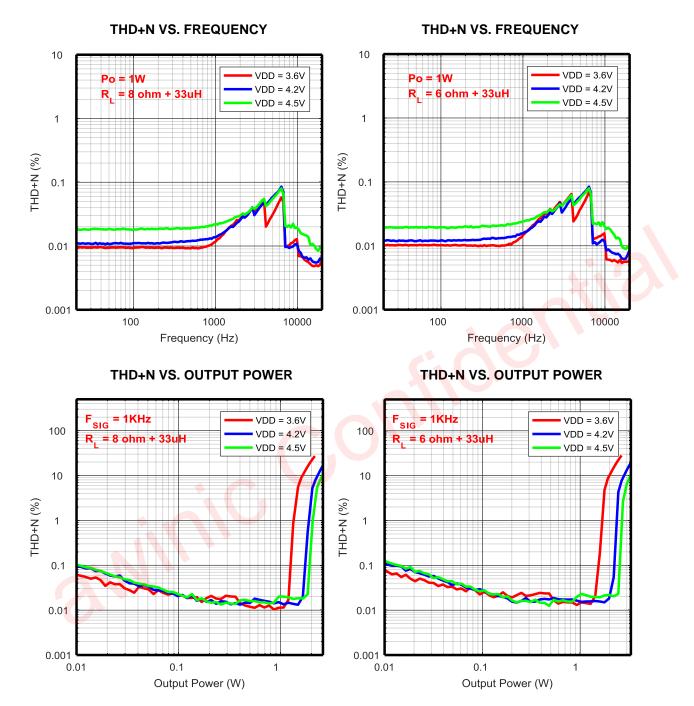
I²S INTERFACE TIMING

	Parameter Name	Min	Тур.	Max	Units
fs	Sampling frequency, on pin WCK	8		96	kHz
f _{вск}	Bit clock frequency, on pin BCK	32 f _S		64 f _s	Hz
t _{su}	WCK, DATAI Setup time to BCK	10			ns
th	WCK, DATAI hold time to BCK	10			ns
t _d	DATAO output delay time to BCK			50	ns



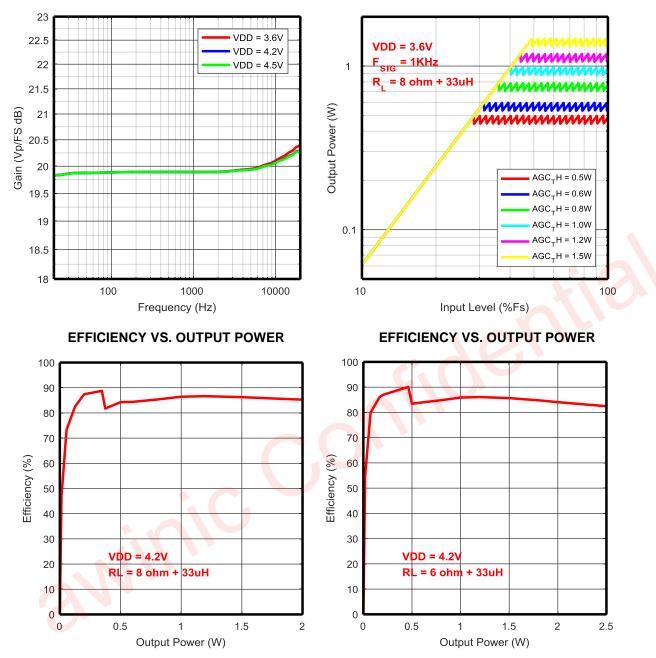


TYPICAL CHARACTERISTICS



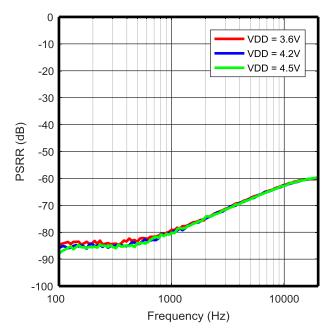
GAIN VS. FREQUENCY

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PSRR VS. FREQUENCY

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DETAILED FUNCTIONAL DESCRIPTION

POWER ON RESET

The device provides a power-on reset feature that is controlled by VDD and DVDD supply voltage. When the VDD supply voltage raises from 0V to 2.1V, or DVDD supply voltage raises from 0V to 1.1V. The reset signal will be generated to perform a power-on reset operation, which will reset all circuits and configuration registers.

OPERATION MODE

The device supports 4 operation modes.

Table 1	Operating Mod	е
---------	----------------------	---

Mode	Condition	Description	
Power-Down	V _{DD} < 2.1V V _{DVDD} < 1.1V	Power supply is not ready, chipset is power down.	
Stand-By	V _{DD} > 3V V _{DVDD} > 1.65V	Power supply is ready, most parts of the device are power down for low power consumption except I ² C interface	
Configuring	PWDN = 0	Device is biased while Charge Pump and Class-K output is floating. Configuring DAP(Digital Audio Processor)	
Operating	AMPPD = 0	Amplifier is fully operating	

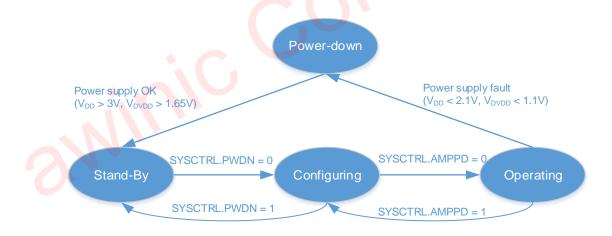


Figure 7 Device operating modes transition

POWER-DOWN MODE

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The device switches to power-down mode when any of the following events occurred:

- V_{DVDD} < 1.1 V
- V_{DD} < 2.1 V
- RSTN pin goes LOW

In this mode, all circuits inside this device will be shut down except the power-on-reset circuit. I²C interface isn't accessible in this mode, and all of the internal configurable registers are cleared.

The device will jump out of the power-down mode automatically when all of the supply voltages are OK:

 V_{DVDD} > 1.65 V and V_{DD} > 3 V

And RSTN goes HIGH.

STAND-BY MODE

The device switches stand-by mode when the power supply voltages are OK. In this mode I²C interface is accessible, other modules are still powered down. Customer can set device to mode when the device is no needed to work.

CONFIG MODE

The device switches to OFF mode when:

- SYSCTRL.PWDN = 0
- SYSCTRL.AMPPD = 1

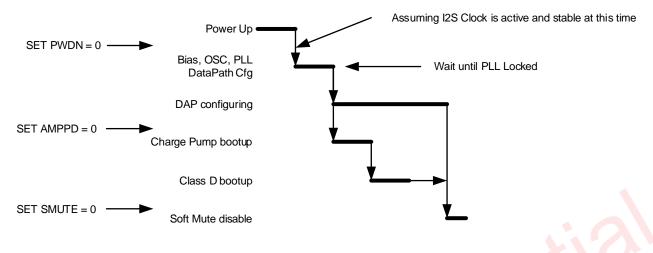
In this mode the internal bias, OSC, PLL will start to work

OPERATING MODE

The device is fully operational in this mode. Charge pump, amplifier loop and power stage circuits will start to work. Customer can set SYSCTRL.AMPPD = 0 to make device in this mode.

POWER UP SEQUENCE

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This device power up sequence is illustrated in the following figure:

Figure 8 Power up sequence

Detail description for each step is listed in the following table.

Table 2 Detail Description of Power up sequence

Index	Description	Mode		
1	Wait for VDD, DVDD supply power up	Power-Down		
2	I ² S + Data Path Configuration	Stand-By		
3.1	Enable system (SYSCTRL.PWDN = 0)			
3.2	Bias, OSC, PLL active	Orafiansiaa		
3.3	Waiting for PLL locked	Configuring		
4a.1	DAP Configuration			
4a.2	DAP enable			
4b.1	Charge pump and Amplifier boot up			
4b.2	Wait SYSST.SWS =1	Operating		
5	Release Hard-Mute Data Path active			

Power up sequence considering I²S, I²C timing shows as below:

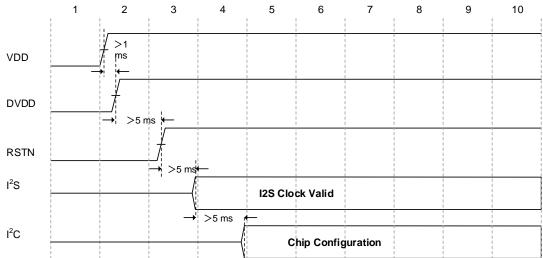
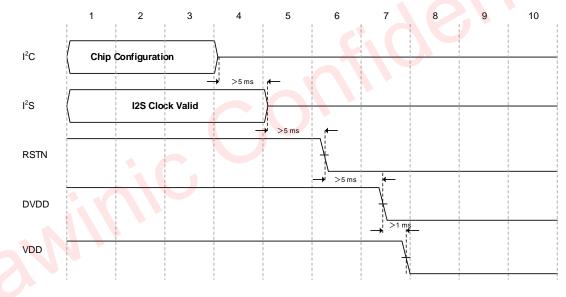


Figure 9 Power Up Sequence

Power down sequence considering I²S, I²C timing shows as below:





SOFTWARE RESET

Writing 0x55AA to register ID via I²C interface will reset the device internal circuits and all configuration registers.

DIGITAL AUDIO INTERFACE

Audio data is transferred between the host processor and the device via the Digital Audio Interface. The digital audio interface is in full-duplex via 4 dedicated pins:

- BCK
- WCK

DATAI

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DATAO

Two-slot I²S is supported in this device. The digital audio Interface on this device is slave only and flexible with data width options, including 16, 20, 24, or 32 bits by configurable registers.

Three modes of I²S are supported, including standard I²S mode, left-justified mode and right-justified mode, which can be configured via I2SCTRL.I2SMD. These modes are all MSB-first, with data width programmable via I2SCTRL.I2SFS.

The word clock WCK is used to define the beginning of a frame. The frequency of this clock corresponds to the sampling frequency. The device supports the following sample rates (fs): 8 kHz, 11.025 kHz, 12 kHz, 16 kHz, 22.05 kHz, 24 kHz, 32 kHz, 44.1 kHz, 48 kHz and 96 kHz. It is selected via configurable register I2SCTRL.I2SSR.

The bit clock BCK is used to sample the digital audio data across the digital audio interface. The number of bit-clock pulses in a frame is defined as slot length. Three kind of slot length are supported (16/24/32) via configurable register I2SCTRL.I2SBCK. The frequency of BCK can be calculated according to the following equation:

BCK frequency = SampleRate x SlotLength x SlotNumber

SampleRate: Sample rate for this digital audio interface;

SlotLength: The length of one audio slot in unit of BCK clock;

SlotNumber: 2-slot supported in I2S mode.

The word select and bit clock signals of the I²S input are the reference signals for the digital audio interface and Phased Locked Loop (PLL).

The input audio data can be attenuated -6dB in this module, by setting bit I2SCTRL.INPLEV. The audio source can be from left channel, right channel or the average of the left and right channel, which is controlled by I2SCTRL.CHSEL.

Interface format(MSB first)	Data width	BCK frequency
Standard I ² S	16b 20b/24b/32b	32 fs /48 fs /64 fs 48 fs /64 fs
Left-justified	16b 20b/24b/32b	32 fs /48 fs /64 fs 48 fs /64 fs
Right-justified	16b 20b/24b/32b	32 fs /48 fs /64 fs 48 fs /64 fs

Table 3 Supported I²S interface parameters

The output port DATAO, can be enabled or disabled via bit I2SCFG1.I2STXEN. The unused slots can be set to zero or Hi-Z, which is controlled by I2SCFG1.DOHZ.

STANDARD PS MODE:

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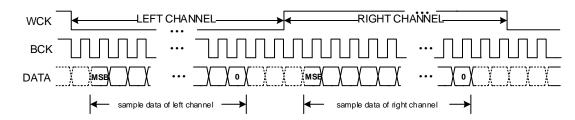


Figure 11 I²S Timing for Standard I²S Mode

- When WCK=0 indicating the left channel data, and WCK=1 indicating the right channel data.
- The MSB of the left channel is valid on the second rising edge of the bit clock after the falling edge of the word clock. Similarly the MSB of the right channel is valid on the second rising edge of the bit clock after the rising edge of the word clock.



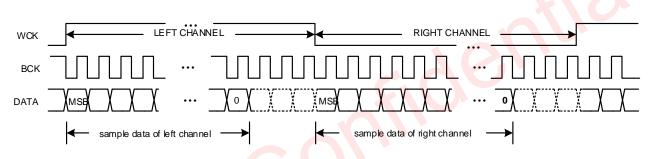


Figure 12 I²S Timing for Left-Justified Mode

- When WCK=1 indicating the left channel data, and WCK=0 indicating the right channel data.
- The MSB of the left channel is valid on the first rising edge of the bit clock after the falling edge of the word clock. Similarly the MSB of the right channel is valid on the first rising edge of the bit clock after the rising edge of the word clock.

RIGHT-JUSTIFIED MODE:

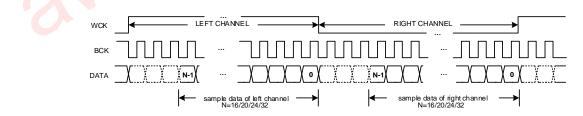


Figure 13 I²S Timing for Right-Justified Mode

- When WCK=1 indicating the left channel data, and WCK=0 indicating the right channel data.
- The LSB (bit 0) of the left channel is valid on the rising edge of the bit clock preceding the falling edge of the word clock. Similarly, the LSB (bit 0) of the right channel is valid on the rising edge of the bit clock preceding the rising edge of the word clock.

DIGITAL AUDIO PROCESSING

This device provides algorithm supporting for audio signal processing. The following functions are processed in this module.

• DCC

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- AGC
- Volume control
- Mute

The signal processing flow in the DAP(Digital Audio Processor) is illustrated in the following figure.

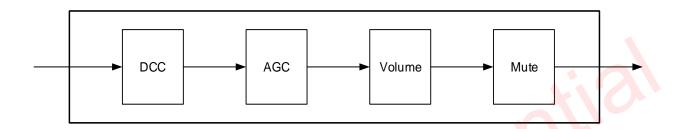


Figure 14 Block Diagram of DAP

DCC

This module perform DC canceling for the input audio stream. Blocking DC components into analog class D loop.

AGC

In the actual audio application, system output power tends to be more than rated power of speaker, such as in the 6V power supply, as for 80hms speaker, the maximum undistorted power is about 1.8W, but many speakers' rated power is about 1W, if there is no output power control, the overload signal can cause damage to the speaker. The audio power amplifier with AGC can protect the speaker effectively, When the output power is not exceeds the setting threshold, the AGC module will not attenuate the internal gain. Once the output power exceeds the setting threshold, the AGC module will reduce the internal gain of amplifier and restricts the output power under the setting threshold.

VOLUME CONTROL

The volume control function attenuates the audio signal at the end of digital audio processing. The range of volume setting is from 0db to -96db with 0.5db/step

MUTE

This module perform mute control for the audio stream.

CHARGE PUMP

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This device adopts a new generation of charge pump technology: K-Chargepump structure. It has higher efficiency and larger driving capability. Its operating frequency is 1.06MHz. With built-in soft-start circuit, current-limit control loop and over-voltage-protection (OVP) loop, charge pump of this configuration can provide more stable and reliable power supply. The Charge Pump can work in different mode via CPCTRL.CP_MD:

- Pass-through mode: the voltage of VDD is transparently passed to output of converter PVDD
- Force CP mode: the output voltage is 1.5 times of supply voltage VDD
- Adaptive CP mode: the output voltage can be switch between VDD and 1.5 times of V_{DD} according to the input audio level.

Pass-through mode

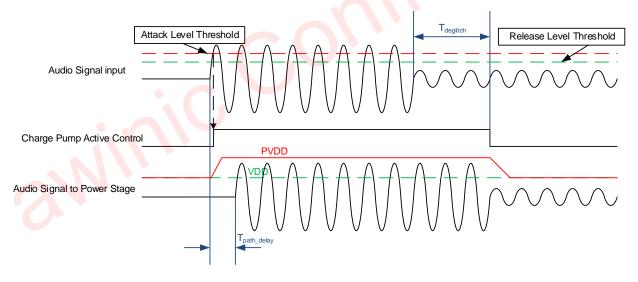
The internal Charge Pump circuit is not working; the voltage of VDD is passed to PVDD directly.

Force CP mode

The Charge Pump circuit is always working and the output voltage is 1.5 times of supply voltage VDD.

Adaptive CP mode

The Charge Pump circuits working dynamically according to the input audio level. When the level of input audio signal is below the setting threshold, the Charge Pump circuit will not work. Till the level of input audio signal raised up and above the threshold, the Charge Pump circuit starts to work and boost the amplifier supply rail to 1.5 times of supply voltage VDD before the audio signal arriving amplifier power stage.





HIGH EFFICIENCY

The output voltage PVDD is 1.5 times of supply voltage VDD in K-Chargepump, of which the ideal efficiency can reach 100%. Actually, the K-Chargepump efficiency can be calculated as the ratio of output power to input power, that is

$$\eta = \frac{P_{OUT}}{P_{IN}} \times 100\%$$

For example, in an ideal M-times charge pump, the input current I_{IN} is M times of the output current I_{OUT} , the efficiency formula can be written as:

$$\eta = \frac{P_{OUT}}{P_{IN}} \times 100\% = \frac{V_{OUT} \cdot I_{OUT}}{V_{IN} \cdot M \cdot I_{OUT}} \times 100\% = \frac{V_{OUT}}{M \cdot V_{IN}} \times 100\%$$

Also, M is a parameter depending on the operating mode of a charge pump; VOUT is the output voltage of a charge pump; VIN is the input voltage (generally is also the power supply voltage) of a charge pump; I_{OUT} is also the load current. For K-Chargepump structure, the output voltage is 1.5 times of the input voltage. Due to the switch loss and quiescent current loss inside the charge pump, the actual efficiency can still be up to 93%. As a result, the power booster technology of K-Chargepump can greatly improve the power efficiency.

CHARGE PUMP STRUCTURE

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As shown in Figure 16 is a Charge Pump fundamental functional diagram: Charge Pump integrated in AW8838 has seven switches, of which the output voltage PVDD is boosted to 1.5 times as input voltage V_{DD} through seven switches operating timing.

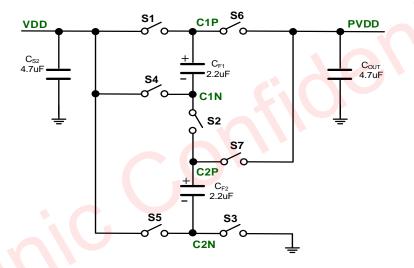


Figure 16 K-Chargepump Functional Diagram

The operation of the charge pump has two phases. In Φ_1 , as shown in Figure 17, when switches S1, S2 and S3 are closed, VDD charges to the flying capacitor C_{F1} and C_{F2}.

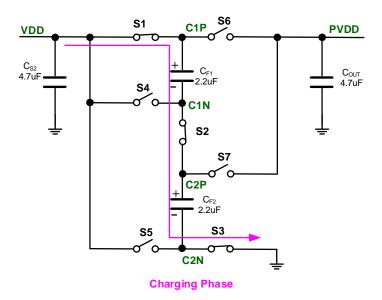
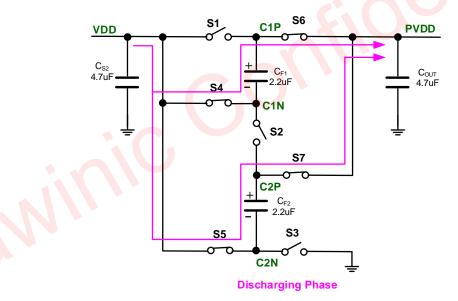


Figure 17 Φ1: Charge Flying Capacitors CF1 and CF2

In Φ_2 , as shown in Figure 18, switches S1, S2 and S3 are opened, and switches S4, S5, S6 and S7 are closed. Because the voltage across the capacitor can't change instantaneously, so either the voltage on flying capacitors C_{F1} or C_{F2}, is added to the VDD, realizing a PVDD boosted to a higher voltage.





SOFT START

K-chargepump has integrated soft start function in order to limit inrush current from power supply during start-up. The current from power supply can be limited to 300mA, and the start-up time is about 1ms.

PEAK CURRENT CONTROL

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K-chargepump has integrated a peak current control circuit. In normal operation, when a heavy load or a situation that makes the charge pump extracts very large current from power supply, the peak current control circuit can limit the maximum output load current, which is typically 2A.

PROTECTION MECHANISMS

Over Voltage Protection (OVP)

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K-Chargepump keeps the output voltage PVDD a multiple of the input voltage VDD. It provides a high voltage power rail for internal power amplifier circuits, allowing the amplifiers provide greater output dynamic range in the lithium battery voltage range, realizing much larger volume, higher audio quality. K-Chargepump has integrated an over-voltage protection circuit. When the input voltage VDD is greater than 4V, the output voltage PVDD is no longer a multiple of VDD, but a controlled voltage by over-voltage protection (OVP) circuit and kept in 6V. The hysteresis voltage of OVP is about 50mV.

Over Temperature Protection (OTP)

The device has automatic temperature protection mechanism which prevents heat damage to the chip. It is triggered when the junction temperature is larger than the preset temperature high threshold (default = 160° C). When it happens, the output stages will be disabled. When the junction temperature drops below the preset temperature low threshold (less than 130° C), the output stages will start to operate normally again

Over current (short) protection (OCP)

The short circuit protection function is triggered when VOP/VON is short to PVDD/GND or VOP is short to VON, the output stages will be shut down to prevent damage to itself. When the fault condition is disappeared, the output stages of device will restart.

RECEIVER MODE

The device built-in Receiver mode is easy to realize the Speaker and Receiver combo applications, it saves the system cost and board space. Speaker and Receiver combo applications can be realized without changing any hardware.

When the device is set to receiver mode, the power supply of Class D driver stage is from VDD directly.

AMPLIFIER TRANSFER FUNCTION

The transfer function from the input to the amplifier PWM output (when no gain and attenuation is applied in digital signal domain) is:

$$V_o = AMP_NORM_V \times D_{in}$$

Din: the level of input signal with a range from -1 to +1

AMP_NORM_V: the equivalent amplifier output voltage when D_{in} is 1. In receiver mode the AMP_NORM_V is 4.5V. In speaker mode the default AMP_NORM_V is 10V, and it is selected via configurable register AMPCTRL.AMP_NORM_V.

I²C INTERFACE

This device supports the I²C serial bus and data transmission protocol in fast mode at 400kHz. This device operates as a slave on the I²C bus. Connections to the bus are made via the open-drain I/O pins SCL and SDA. The pull-up resistor can be selected in the range of $1k\sim10k\Omega$ and the typical value is $4.7k\Omega$. This device can support different high level ($1.8V\sim3.3V$) of this I²C interface.

DEVICE ADDRESS

The I²C device address (7-bit) is decided by the connection of the AD pin. The connection of AD pin configures

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the two LSB bits of the following 7-bit binary address A6-A0 of 01101xx. The permitted I²C addresses are 0x34(7bit) through 0x37(7-bit).

AD pin	A1	A0	I2C address (7-bit)
Connects to GND	0	0	0x34
Connects to SCL	0	1	0x35
Connects to SDA	1	0	0x36
Connects to VDD	1	1	0x37

Table 4 Address Selection

DATA VALIDATION

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When SCL is high level, SDA level must be constant. SDA can be changed only when SCL is low level.

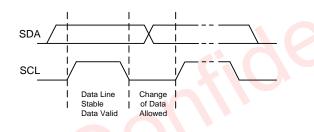


Figure 19 Data Validation Diagram

PC START/STOP

I²C start: SDA changes form high level to low level when SCL is high level.

I²C stop: SDA changes form low level to high level when SCL is high level.

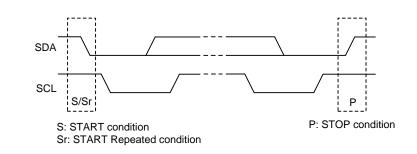


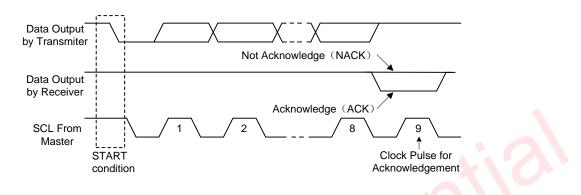
Figure 20 I²C Start/Stop Condition Timing

ACK (ACKNOWLEDGEMENT)

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ACK means the successful transfer of I²C bus data. After master sends 8bits data, SDA must be released; SDA is pulled to GND by slave device when slave acknowledges.

When master reads, slave device sends 8bit data, releases the SDA and waits for ACK from master. If ACK is send and I²C stop is not send by master, slave device sends the next data. If ACK is not send by master, slave device stops to send data and waits for I²C stop.





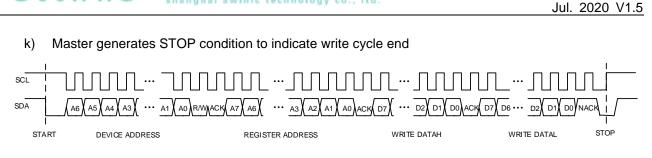
WRITE CYCLE

One data bit is transferred during each clock pulse. Data is sampled during the high state of the serial clock (SCL). Consequently, throughout the clock's high period, the data should remain stable. Any changes on the SDA line during the high state of the SCL and in the middle of a transaction, aborts the current transaction. New data should be sent during the low SCL state. This protocol allows a single data line to transfer both command/control information and data using the synchronous serial clock.

Each data transaction is composed of a Start Condition, a number of byte transfers (set by the software) and a Stop Condition to terminate the transaction. Every byte written to the SDA bus must be 8 bits long and is transferred with the most significant bit first. After each byte, an Acknowledge signal must follow.

In a write process, the following steps should be followed:

- a) Master device generates START condition. The "START" signal is generated by lowering the SDA signal while the SCL signal is high.
- b) Master device sends slave address (7-bit) and the data direction bit (r/w = 0).
- c) Slave device sends acknowledge signal if the slave address is correct.
- d) Master sends control register address (8-bit)
- e) Slave sends acknowledge signal
- f) Master sends high data byte of 16-bit data to be written to the addressed register
- g) Slave sends acknowledge signal
- h) Master sends low data byte of 16-bit data to be written to the addressed register
- i) Slave sends acknowledge signal
- j) If master will send further 16-bit data bytes the control register address will be incremented by one after acknowledge signal of step g (repeat step f to g)



AW8838

Figure 22 I²C Write Byte Cycle

READ CYCLE

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In a read cycle, the following steps should be followed:

- a) Master device generates START condition
- b) Master device sends slave address (7-bit) and the data direction bit (r/w = 0).

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- c) Slave device sends acknowledge signal if the slave address is correct.
- d) Master sends control register address (8-bit)
- e) Slave sends acknowledge signal
- f) Master generates STOP condition followed with START condition or REPEAT START condition
- g) Master device sends slave address (7-bit) and the data direction bit (r/w = 1).
- h) Slave device sends acknowledge signal if the slave address is correct.
- i) Slave sends read high data byte of 16-bit data from addressed register.
- j) Master sends acknowledge signal.
- k) Slave sends read low data byte of 16-bit data from addressed register.
- I) If the master device sends acknowledge signal, the slave device will increase the control register address by one, then send the next 16-bit data from the new addressed register.
- m) If the master device generates STOP condition, the read cycle is ended.

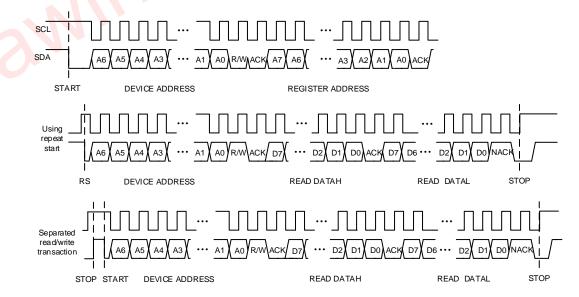


Figure 23 I²C Read Byte Cycle

REGISTER CONFIGURATION

Register List

									BIT								
ADDR	NAME	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0x00	ID								IDCODE							-	
0x01	SYSST		UVLS	ADPS		OVPS		VOUTHS	SWS			NOCLKS	CLKS	OCDS	OTLS	OTHS	PLLS
0x02	SYSINT		UVLI	ADPI		OVPI		VOUTHI	SWI			NOCLKI	CLKI	OCDI	OTLI	ОТНІ	PLLI
0x04	SYSCTRL			-						RCV_MODE	I2SEN	WSINV	BCKINV	IPLL		AMPPD	PWDN
0x05	I2SCTRL			INPLEV		CI	HSEL	125	SMD	I2SFS	;	I2SBC	ск		125	SR	
0x06	I2SCFG1											DRVSTREN	DOHZ				I2STXEN
0x08	PWMCTRL															HDCCE	HMUTE
0x10	HAGCCFG0												AVT	Н			
0x13	HAGCCFG1								ATTH_NORM	1							
0x14	HAGCCFG2												RVT	н			
0x15	HAGCCFG3								RTTH	-							
0x16	HAGCCFG4												HOLD	ΤΗ			
0x17	HAGCCFG5						HPFE		AGCE								
0x18	HAGCCFG5						HPFE		AGCE								
0x21	I2SCFG2																I2SRXEN
0x50	HPFCFG1								a1								
0x51	HPFCFG2		2N						a2								
0x52	HPFCFG3								b0								
0x53	HPFCFG4		b1														
0x54	HPFCFG5						1	n	b2	1							
0x60	CPCTRL						VPWR_SEL	CP	_MD		C	P_RTH			CI	P_ATH	
0x63	AMPCTRL			AMP_NORM_V													

REGISTER DETAILED DESCRIPTION

ID: Chip ID Register (Address 00h)

Bit	Symbol	R/W	Description	Default
15:0	IDCODE	R	Chip ID (1730h) will be returned after read. All configuration registers will be reset to default value after 0x55aa is written	0x1730

SYSST: System Status Register (Address 01h)

Bit	Symbol	R/W	Description	Default
15	Reserved	-	Reserved	
14	UVLS	R	VDD under voltage indicator 1: VDD < 2.5V; 0: VDD > 2.6V	
13	ADPS	R	Charge Pump Adaptive status 0: transparent; 1: 1.5X	
12	Reserved	-	Reserved	
11	OVPS	R	Charge Pump OVP status indicator	
10	Reserved	-	Reserved	
9	VOUTHS	R	Charge Pump voltage indicator 1: PVDD > VDD + 0.2V; 0: PVDD < VDD + 0.2V	
8	SWS	R	Amplifier switching status 1:switching; 0:not switching	
7:6	Reserved	•	Reserved	
5	NOCLKS	R	The reference clock of PLL is not available	
4	CLKS	R	All internal clock are stable	
3	OCDS	R	Over current status in amplifier	
2	OTLS	R	Junction temperature is above 150°C	
1	OTHS	R	Junction temperature is above 160°C	
0	PLLS	R	PLL locked status 1: locked; 0: unlocked	

SYSINT: System Interrupt Register (Address 02h)

Bit	Symbol	R/W	Description	Default
15	Reserved	RC	Reserved	
14	UVLI	RC	Interrupt indicator for Power On and UVLS	
13	ADPI	RC	Interrupt indicator for ADPS	
12	Reserved	-	Reserved	
11	OVPI	RC	Interrupt indicator for OVPS	
10	Reserved	-	Reserved	
9	VOUTHI	RC	Interrupt indicator for VOUTHS	
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Bit	Symbol	R/W	Description	Default				
8	SWI	RC	Interrupt indicator for SWS					
7:6	Reserved	-	Reserved					
5	NOCLKI	RC	Interrupt indicator for NOCLKS					
4	CLKI	RC	Interrupt indicator for CLKS					
3	OCDI	RC	Interrupt indicator for OCDS					
2	OTLI	RC	Interrupt indicator for OTLS					
1	ОТНІ	RC	Interrupt indicator for OTHS					
0	PLLI	RC	Interrupt indicator for PLLS					
Note: It v	Note: It will be set to '1' once corresponding interrupt bit changed							

SYSCTRL: System Control Register (Address 04h)

SYSCTRL	: System Control R	egister	(Address 04h)	
Bit	Symbol	R/W	Description	Default
15:8	Reserved	-	Reserved	
7	RCV_MODE	RW	Receiver mode enable	0x0
6	I2SEN	RW	Enable/Disable whole I2S interface module 0: disable 1: enable	0x0
5	WSINV	RW	I2S Left/Right channel switch 0: No switch 1: Left/Right switch	0x0
4	BCKINV	RW	I2S bit clock invert control 0: not invert 1: inverted	0x0
3	IPLL	RW	PLL reference clock selection 0: bit clock 1: word selection signal	0x0
2	Reserved	-	Reserved	
1	AMPPD	RW	Amplifier power down control bit 0: Amplifier active 1: Amplifier power down	0x1
0	PWDN	RW	System power down control bit 0: active 1: All circuits will enter power down mode	0x1

I2SCTRL: I2S interface Control Register (Address 05h)

Bit	Symbol	R/W	Description	Default
15:14	Reserved	-	Reserved	
13	INPLEV	RW	Input level selection 0: All input signal will not be attenuated at first 1: All input signal will be attenuated by -6dB at first	0x0
12	Reserved	-	Reserved	



Bit	Symbol	R/W	Description	Default
11:10	CHSEL	RW	Left/right channel selection for I2S input 0: reserved 1: left 2: right 3: mono;(L+R)/2	0x1
9:8	I2SMD	RW	I2S interface mode 0: Philip standard I2S 1: MSB justified 2: LSB justified 3: Reserved	0x0
7:6	I2SFS	RW	I2S data width 0: 16 bits 1: 20 bits 2: 24 bits 3: 32 bits	0x3
5:4	I2SBCK	RW	I2S BCK mode 0: 32 fs 1: 48 fs 2: 64 fs 3: Reserved	0x2
3:0	I2SSR	RW	I2S interface sample rate configuration: 0: 8 kHz 1: 11.025 kHz 2: 12 kHz 3: 16 kHz 4: 22.05 kHz 5: 24 kHz 6: 32 kHz 7: 44.1 kHz 8: 48 kHz 9: 96 kHz 10: Reserved 11~15: 48 kHz	0x8

I2SCFG1: I2S Channel Configuration Register 1(Address 06h)

Bit	Symbol	R/W	Description	Default
15:6	Reserved	-	Reserved	
5	DRVSTREN	RW	I2S_DATAO PAD driving strength setting 0: 2mA 1: 8mA	0x1
4	DOHZ	RW	Unused channel data mode 0: 0 1: HiZ	0x1
3:1	Reserved	-	Reserved	
0	I2STXEN	RW	Enable/Disable I2S transmitter module 0: disable 1: enable	0x0

PWMCTRL: PWM Control Register (Address 08h)

Bit	Symbol	R/W	Description	Default
15:2	Reserved	-	Reserved	
1	HDCCE	RW	Hardware DC Canceling control 0: hard DC cancel disable 1: hard DC cancel enable	0x1
0	HMUTE	RW	Hardware mute control 0: hard mute disable 1: hard mute enable	0x1

HAGCCFG0: Hardware AGC Configuration Register 0 (Address 10h)

Bit	Symbol	R/W	Description	Default
15:8	Reserved	-	Reserved	
7:0	AVTH	RW	Attack amplitude threshold of AGC, in percent of signal full scale	0x7F

HAGCCFG1: Hardware AGC Configuration Register 1 (Address 13h)

Bit	Symbol	R/W	Description	Default
15:0	ATTH_NORM	RW	Attack time threshold of AGC in unit of 20.83uS 0: reserved n: gain decreased 0.5dB per n x 20.83uS	0x7

HAGCCFG2: Hardware AGC Configuration Register 2 (Address 14h)

Bit	Symbol	R/W	Description	Default
15:8	Reserved	-	Reserved	
7:0	RVTH	RW	Release amplitude threshold, in percent of signal full scale	0x70

HAGCCFG3: Hardware AGC Configuration Register 3 (Address 15h)

Bit		Symbol	R/W	Description	Default
15:0	0	RTTH	RW	Release time threshold in unit of 20.83uS 0: reserved n: gain increased 0.5dB per n x 20.83uS	0x30

HAGCCFG4: Hardware AGC Configuration Register 4 (Address 16h)

Bit	Symbol	R/W	Description	Default
15:8	Reserved	-	Reserved	
7:0	HOLDTH	RW	Hold time threshold in unit of 166uS 0: reserved n: attack counter holding as least n x 166uS	0x60

HAGCCFG5: Hardware AGC Configuration Register 5 (Address 17h)

Bit	Symbol	R/W	Description	Default
15:11	Reserved	-	Reserved	
10	HPFE	RW	HPF control 0: HPF disable 1: HPF enable	0x0
9	Reserved	-	Reserved	
8	AGCE	RW	AGC control 0: AGC disable 1: AGC enable	0x0
7:0	Reserved	-	Reserved	

HAGCCFG6: Hardware AGC Configuration Register 6 (Address 18h)

Bit	Symbol	R/W	Description	Default
15:8	VOL	RW	Volume control, from 0 to -96dB [3:0] : in unit of -0.5dB [7:4] : in unit of -6dB	0x00
7:0	Reserved	-	Reserved	0x00

I2SCFG2: I2S Channel Configuration Register 2 (Address 21h)

Bit	Symbol	R/W	Description	Default
15:1	Reserved	-	Reserved	
0	I2SRXEN	RW	Enable/Disable I2S receiver module 0: disable 1: enable	0x1

HPFCFG1: HPF Configuration Register 1 (Address 50h)

Bit	Symbol	R/W	Description	Default
15:0	a1	RW	HPF filter coefficient a1	0xE04C

HPFCFG2: HPF Configuration Register 2 (Address 51h)

Bit	Symbol	R/W	Description	Default

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15:0 a2	RW	HPF filter coefficient a2	0xFB5
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HPFCFG3: HPF Configuration Register 3 (Address 52h)

	Bit	Symbol	R/W	Description	Default
ſ	15:0	b0	RW	HPF filter coefficient b0	0x1000

HPFCFG4: HPF Configuration Register 4 (Address 53h)

Bit	Symbol	R/W	Description	Default
15:0	b1	RW	HPF filter coefficient b1	0xE000

HPFCFG5: HPF Configuration Register 5 (Address 54h)

Bit	Symbol	R/W	Description	Default
15:0	b2	RW	RW HPF filter coefficient b2	

CPCTRL: CP Control Register (Address 60h)

15.0	02			001000		
CPCTRL: CP Control Register (Address 60h)						
Bit	Symbol	R/W	Description	Default		
15:11	Reserved	-	Reserved			
10	PWL_SEL	RW	Supply power selection 0: normal option 1: high voltage option	0x0		
9:8	CP_MD	RW	Charge Pump mode selection 0: Transparent Mode 1: Adaptive Mode 2: Force 1.5X Mode 3: Reserved			
7:4	CP_RTH	RW	Adaptive Charge Pump release threshold in unit of 3.125%	0x3		
3:0	CP_ATH	RW	Adaptive Charge Pump attack threshold in unit of 3.125%			

AMPCTRL: AMP Control Register (Address 63h)

Bit	Symbol	R/W	Description	Default
15:14	Reserved	-	Reserved	
13	AMP_NORM_V	RW	Amplifier output gain selection in speaker mode 0: 7V 1: 10V	0x1
12:0	Reserved	-	Reserved	

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APPLICATION INFORMATION

EXTERNAL COMPONENTS

SECLECTION OF SUPPLY DECOUPLING CAPACITOR

The device is a high-performance audio amplifier that requires adequate power supply decoupling. Place a low equivalent-series-resistance (ESR) ceramic capacitor, typically 0.1μ F. This choice of capacitor and placement helps with higher frequency transients, spikes, or digital hash on the line. Additionally, placing this decoupling capacitor close to the AW8838 is important, as any parasitic resistance or inductance between the device and the capacitor causes efficiency loss. In addition to the 0.1μ F ceramic capacitor, place a 10μ F capacitor on the VBAT supply trace. This larger capacitor acts as a charge reservoir, providing energy faster than the board supply, thus helping to prevent any droop in the supply voltage.

SELECTION OF CHARGE PUMP FLYING CAPACITOR

Value of charge pump flying capacitors (C_{F1},C_{F2}) affects load regulation and output impedance of the charge pump. Small capacitance may degrade driving capability of AW8838. A 2.2µF/6.3V ceramic capacitor is usually recommended.

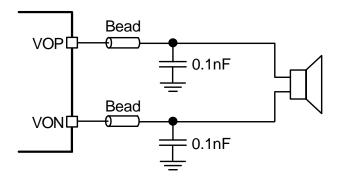
SELECTION OF CHARGE PUMP OUTPUT CAPACITOR

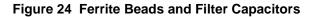
Capacitance and ESR of charge pump output capacitors (C_{OUT}) directly affect ripple magnitude of charge pump output voltage (PVDD). Increasing C_{OUT} Capacitance reduces variations of PVDD and decreasing C_{OUT} ESR also reduces both ripple and output resistance. A 4.7µF/10V ceramic capacitor is usually recommended.

USAGE OF FERRITE BEAD AND FILTER CAPACITOR

Without ferrite beads and filter capacitors, AW8838 can still pass the specifications of FCC and CE. If there is any EMI sensitive device near AW8838 and/or there are long traces routing from the amplifier to a speaker, use ferrite beads and filter capacitors and place beads and capacitors as close as possible to output pins (VOP&VON), as Figure 22 below.

In Speaker Mode, outputs of AW8838 are square-wave PWM signals, which charge and discharge filter capacitors in each period, and result in additional static power consumption. Bigger filter capacitance, larger current consumption. Therefore, 0.1nF ceramic capacitor is usually recommended for low power application.





PCB LAYOUT CONSIDERATIONS

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EXTERNAL COMPONENTS PLACEMENT

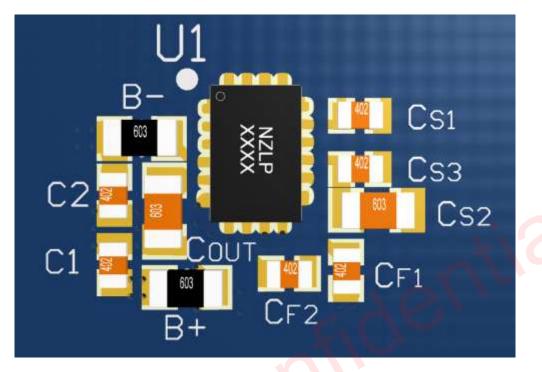


Figure 25 AW8838 External Components Placement

LAYOUT CONSIDERATIONS

In order to exploit best performance of AW8838, PCB layout must be carefully considered. A recommended PCB layout is illustrated as Figure 24 shown. Design consideration should be followed as below:

- 1. Isolated, short and wide power lines for both VDD pin and GND pin are required for better driving-capability of AW8838. The copper width is recommended to be larger than 0.75mm (30mil). Power supply decoupling capacitors should be placed as close as possible to power supply pins.
- Flying capacitors C_{F1}, C_{F2} should be placed as close as possible to C1N, C1P pins and C2N, C2P pins. Likewise, capacitor C_{OUT} should be close to PVDD pin. The trace from C_{OUT} to both PVDD pin and GND pin should be short and wide.
- 3. Ferrite beads and filter capacitors should be close to VON and VOP pins. The trace from output pins to speaker should be short and wide. The copper width is recommended to be larger than 0.5mm (20mil).

S1 00 00 C ٥ 0 0 O 0 32 О O 0 0 0 0 00 00 00 CC.

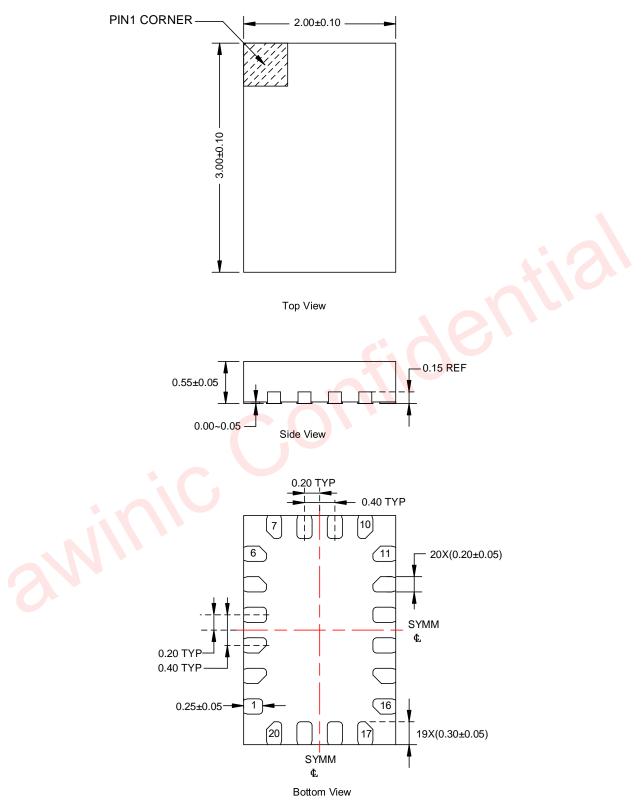
The suggested Layout is illustrated in the following diagram:

Figure 26 AW8838 Board Layout

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PACKAGE DESCRIPTION

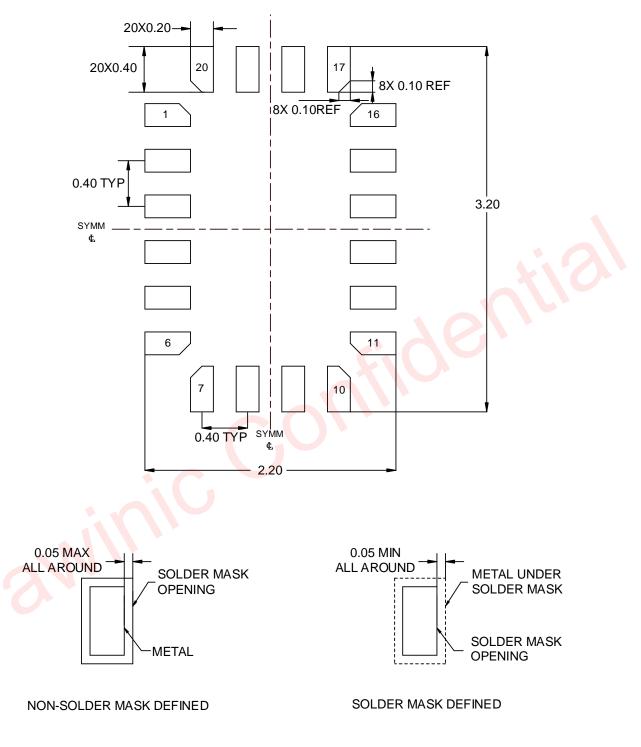
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Unit : mm

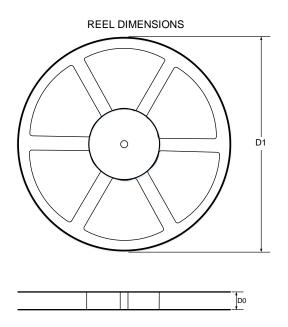
LAND PATTERN DATA

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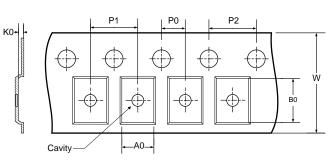


Unit : mm

TAPE AND REEL INFORMATION

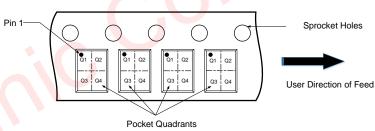


TAPE DIMENSIONS



- A0: Dimension designed to accommodate the component width
- B0: Dimension designed to accommodate the component length
- K0: Dimension designed to accommodate the component thickness
- W: Overall width of the carrier tape
- P0: Pitch between successive cavity centers and sprocket hole
- P1: Pitch between successive cavity centers
- P2: Pitch between sprocket hole
- D1: Reel Diameter
- D0: Reel Width

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



All Dimensions are nominal

D1 (mm)		A0 (mm)						W (mm)	Pin1 Quadrant
330	12.4	2.3	3.3	0.75	2	4	4	12	Q1

REVISION HISTORY

Vision	Date	Change Record			
V1.0	August 2018	Officially Released			
V1.1	January 2019	Updated Package Description and Land Pattern Data			
V1.2	January 2019	Updated Package Information			
V1.3	March 2019	Updated Power-up and Power-down Sequence			
V1.4	July 2019	Updated Land Pattern Data			
V1.5	July 2020	Updated Registers			

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